Cumulative Innovation: Breadth and Standards for Protection

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Policy Objectives: Two Views

1. Divide profit so every generation is protected (recognizing that each generation builds on the last)

2. Ensure efficient "prospecting" (Kitch)

In my testimony of February 26, I focussed on the latter; here I will focus on the former.

Example: Semiconductor Chips

- Expensive to develop (\$40m-\$50) Cheap to clone (\$50K-\$100K).
- Conflicting economic goals:
 - Use prior knowledge for further improvement
 - Protect each innovator against competition
- Semiconductor Chip Protection Act 1984 Allows reverse engineering but has a "forward engineering" or "breadth" requirement
 - Patent-like protection (without disclosure)

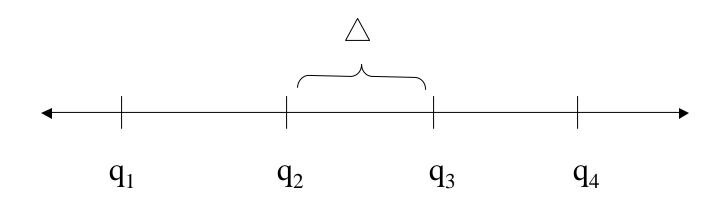
Intellectual Property on a quality ladder.

Basic Problem: There is a large discrepancy between the profit and social value of each incremental improvement:

Benefit of each improvement: \triangle/r

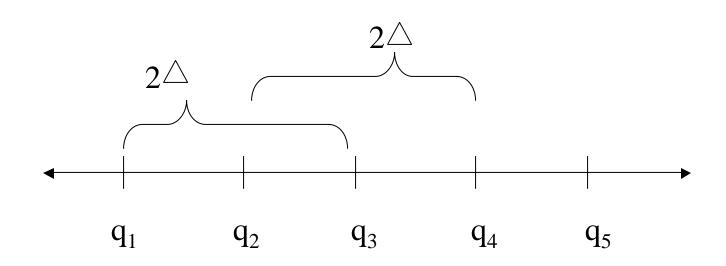
Cost of each improvement: c

Profit earned by each improvement:△



Intellectual Property on a quality ladder.

Two Tools of Intellectual Property



Downside Risk:

• Wrong leading breadth:

Too narrow: competition stifles invention

Too broad: too much consolidation

Wrong patentability Standard:

Standard too high:

Might stifle follow-ons

Solution: Previous patentholders (Kitch)

Standard too low:

Might result in unnecessary patents.

Solution: Make each patent narrow.

Conclusion

- It might be more important to get the (leading) breadth right than to get the standard of patentability right.
- Compare: copyright and patent
 In copyright we have never worried that
 essentially everything (within subject
 matter) is copyrightable.